## **BS223**

## **DMOS Transistors (P-Channel)**

# TO-92 maxØ .022 (0.5<u>5</u>)

Dimensions in inches and (millimeters)

#### **FEATURES**

- High input impedance
- Low gate threshold voltage
- Low drain-source ON resistance
- High-speed switching
- No minority carrier storage time
- CMOS logic compatible input
- No thermal runaway
- No secondary breakdown



#### **MECHANICAL DATA**

Case: TO-92 Plastic Package Weight: approx. 0.18 g

#### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25 °C ambient temperature unless otherwise specified

	Symbol	Value	Unit	
Drain-Source Voltage	-V <sub>DSS</sub>	60	V	
Drain-Gate Voltage	-V <sub>DGS</sub>	60	V	
Gate-Source Voltage (pulsed)	V <sub>GS</sub>	±20	V	
Drain Current (continuous) at T <sub>amb</sub> = 25 °C	-I <sub>D</sub>	1	А	
Power Dissipation at T <sub>amb</sub> = 25 °C	P <sub>tot</sub>	830 <sup>1)</sup>	mW	
Junction Temperature	Tj	150	°C	
Storage Temperature Range	T <sub>S</sub>	-65 to +150	°C	
1) Valid provided that leads are kept at ambient temperat	ure at a distance of 2 mi	m from case.	1	

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#### **Inverse Diode**

	Symbol	Value	Unit
Max. Forward Current (continuous) at T <sub>amb</sub> = 25 °C	l <sub>F</sub>	1	А
Forward Voltage Drop (typ.) at $V_{GS} = 0$ V, $I_F = 1$ mA, $T_j = 25$ °C	V <sub>F</sub>	1.0	V



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### **ELECTRICAL CHARACTERISTICS**

Ratings at 25 °C ambient temperature unless otherwise specified

	Symbol	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage at $-I_D$ = 100 $\mu$ A, $V_{GS}$ = 0 V	-V <sub>(BR)DSS</sub>	60	70	_	V
Gate-Body Leakage Current, Forward at $-V_{GSF} = 20 \text{ V}$ , $V_{DS} = 0 \text{ V}$	-I <sub>GSSF</sub>	_	_	500	nA
Gate-Body Leakage Current, Reverse at –V <sub>GSR</sub> = 20 V, V <sub>DS</sub> = 0 V	-I <sub>GSSR</sub>	_	_	500	nA
Drain Cutoff Current at $-V_{DS} = 60 \text{ V}$ , $V_{GS} = 0 \text{ V}$	-I <sub>DSS</sub>	_	-	250	μА
Gate-Source Threshold Voltage at $V_{GS} = V_{DS}$ , $-I_D = 250 \mu A$	-V <sub>GS(th)</sub>	1	1.5	3	V
Drain-Source ON Resistance at -V <sub>GS</sub> = 10 V, -I <sub>D</sub> = 600 mA	R <sub>DS(on)</sub>	_	0.7	0.8	Ω
Capacitance at -V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz Input Capacitance Output Capacitance Feedback Capacitance	C <sub>iSS</sub> C <sub>OSS</sub> C <sub>rSS</sub>	_ _ _	350 150 35	_ _ _ _	pF pF pF
Switching Times at $-V_{GS}$ = 10 V, $-V_{DS}$ = 10 V, $R_D$ = 100 $\Omega$ Turn-On Time Turn-Off Time	t <sub>on</sub> t <sub>off</sub>		40 100	=	ns ns
Thermal Resistance Junction to Ambient Air	R <sub>thJA</sub>	_	_	150 <sup>1)</sup>	K/W

<sup>&</sup>lt;sup>1)</sup> Valid provided that leads are kept at ambient temperature at a distance of 2 mm from case.

